

# EURONANOFORUM

## Modelling activities as a tool to optimize materials, products, process and performance

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IK4  TEKNIKER

Research Alliance

## Case studies from IK4-TEKNIKER in Modelling :

### Materials and Product Optimization:

- Atomistic modelling and molecular dynamics **nanocomposites and nanopigments**, *Borja Coto* ([borja.coto@tekniker.es](mailto:borja.coto@tekniker.es) ; *Doctoral Thesis*)
- Optimization of a **nebullizer** design, *Jon Lambarri* ([jon.Lambarri@tekniker.es](mailto:jon.Lambarri@tekniker.es) )

### Process Optimization:

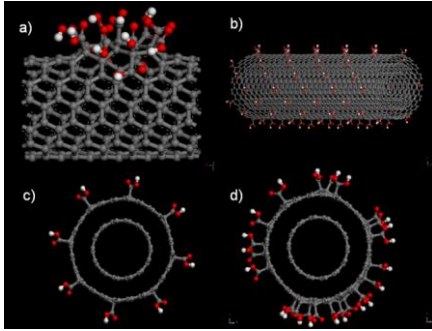
- Numerical modelling in **Laser** processing, *Jon Lambarri*
- **Cutting** operations, *Itxaso Cascón* ([Itxaso.gascon@tekniker.es](mailto:Itxaso.gascon@tekniker.es) )
- **Curing** treatment, *Cristina Monteserin* ([cristina.monteserin@tekniker.es](mailto:cristina.monteserin@tekniker.es), *Doctoral Thesis*)

### Performance Optimization:

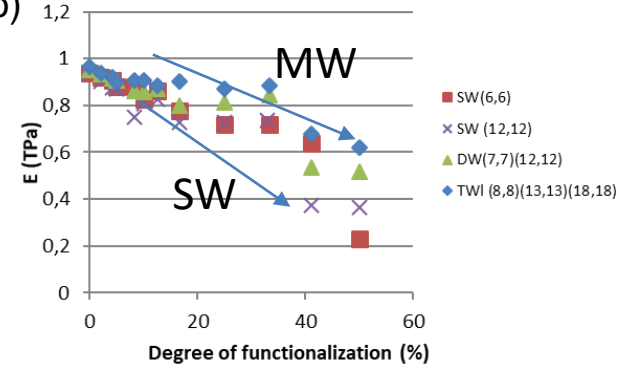
- Modelling **elastomers and Bearings** (Aitor Fernandez, [aitor.fernandez@tekniker.es](mailto:aitor.fernandez@tekniker.es) )
- **Moulds durability** in function of the type of failure modes, *Borja Zabala* ([Borja.zabala@tekniker.es](mailto:borja.zabala@tekniker.es); *Doctoral Thesis*)

**Objective:** innovative polymer composites filled with CNT to obtain nanostructured materials

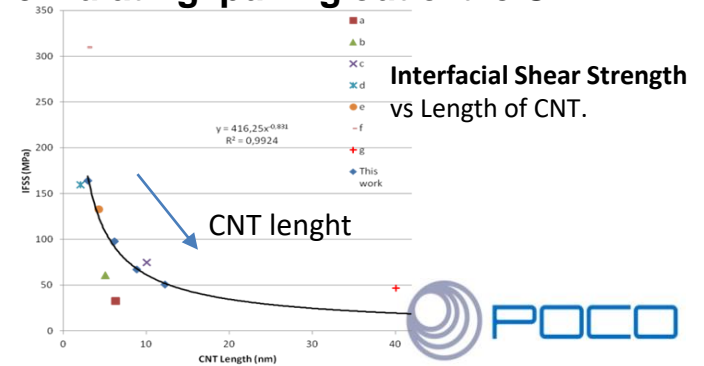
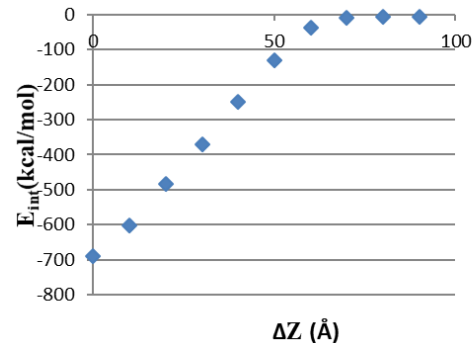
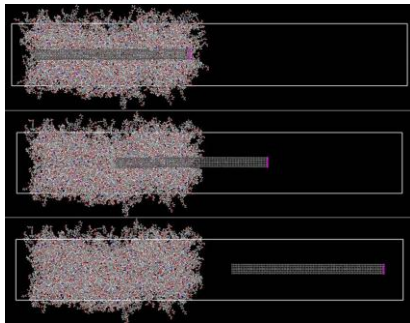
**Modelling goal:** Study the influence of functionalization on mechanical properties of CNTs. **Modelling tool:** MD (Acceleris, Materials Studio)



- Young's modulus **decreases** as % of functionalization increases.
- The decrease is less critical in MWCNT than in SWCNTs

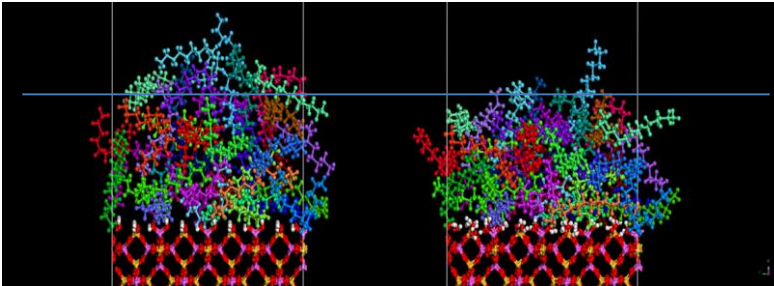


**MD modelling:** Interphase Interaction between CNT & polymeric matrix **simulating pulling out of the CNT.**

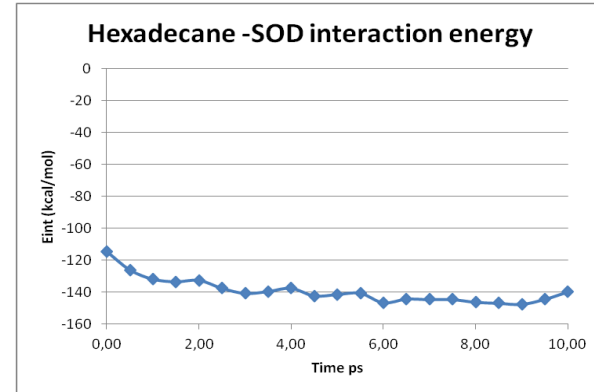


**Project Objective:** develop multi-functional and cost-efficient **ceramic nanopigments** for paint, plastic and concrete

- **Modelling Tools: Atomistic Monte Carlo simulations to study** absorption of molecules (PCM) in porous medium



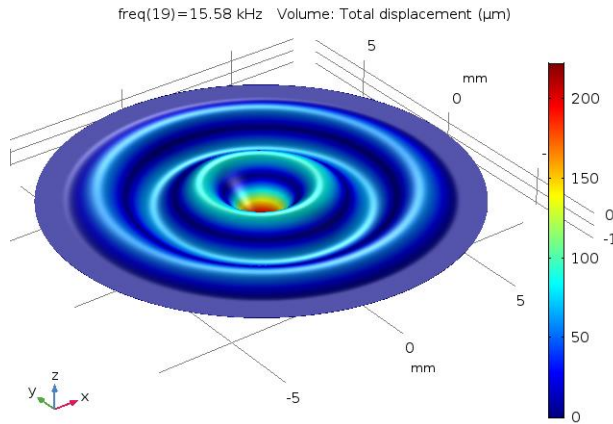
Configurations of hexadecane molecules adsorbed on a surface before and after 10 ps of MD run



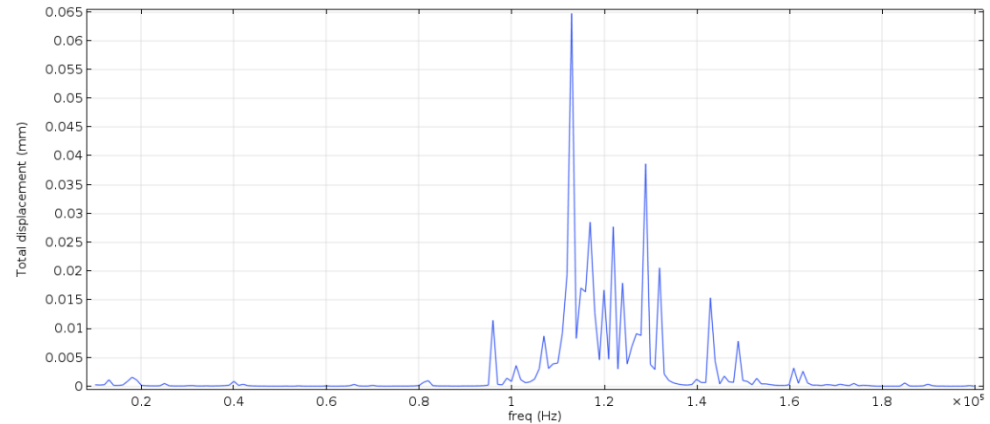
Evolution of the interaction energy between hexadecane molecules layer and the SOD surface

- Evolution (10ps) of **adsorbed molecules** to determine their suitability to be adsorbed in a nano porous surface
- The MD simulation **show the stability** in time of the absorbed layer

- **Objective:** Optimize a nebulizer design and find appropriate operation parameters
- **Modelling Tools:** Multiphysics COMSOL



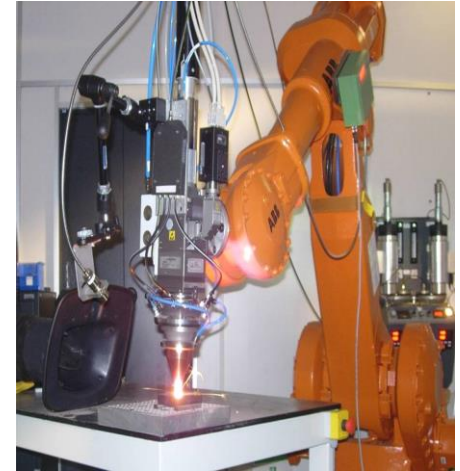
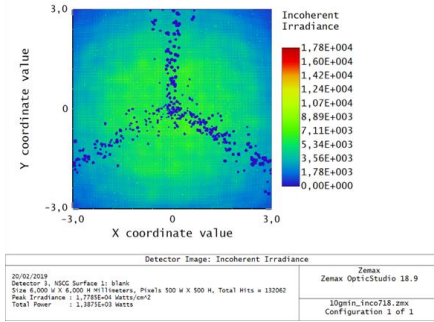
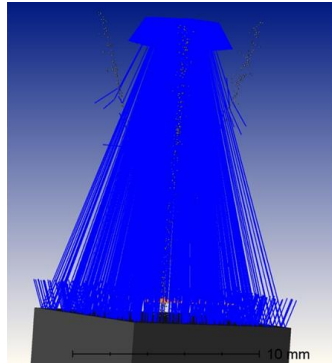
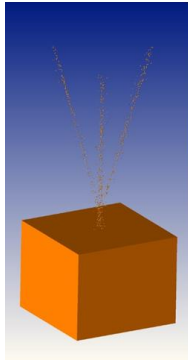
**Piezoelectric** simulation of the membrane



**Output :** Optimized geometry and frequency spectrum

The research leading to these results was carried out in cooperation with **LAINO MEDICAL**

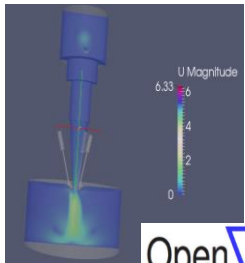
- **Goal:** Study laser-matter interactions for laser additive manufacturing of metals to predict the thermal and mechanical response of the parts
- **Modelling Tools:** ZEMAX, OpenFOAM, SYSWELD



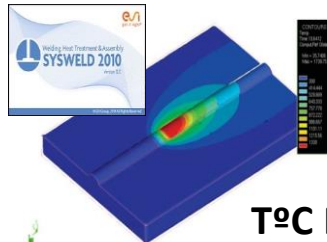
Import powder cloud

Ray tracing from a laser source to the substrate

**Output :** Effective power density distribution for thermo-mechanical FEM simulation

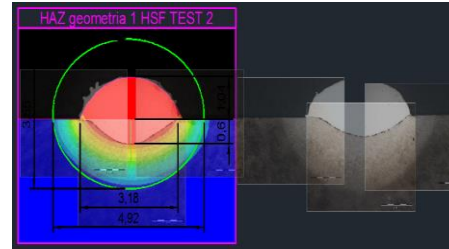


OpenFOAM



(a) External surfaces isotherms

T°C Processing



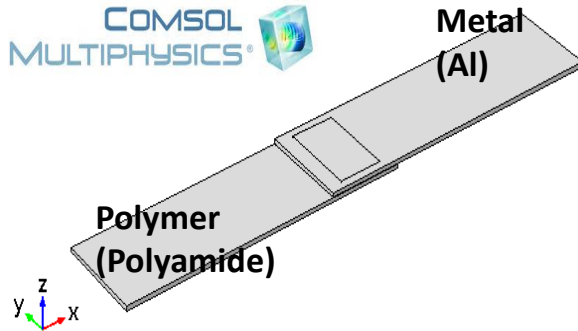
Deposited track geometry



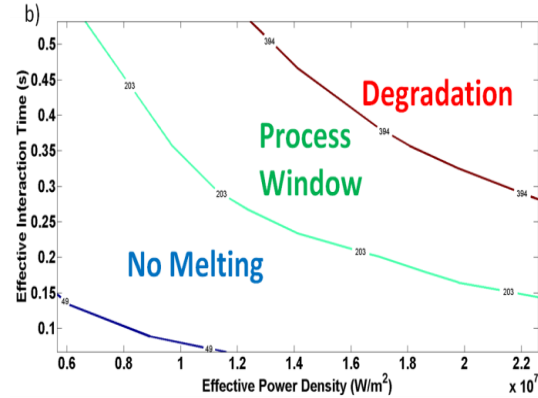
**Goals:** Obtain the process **parameter window** avoiding lack of melting or polymer degradation

**Modelling tools:** COMSOL Multiphysics

**Applications:** Hybrid components for lightweight structures



Test part configuration



Numerical parameter map

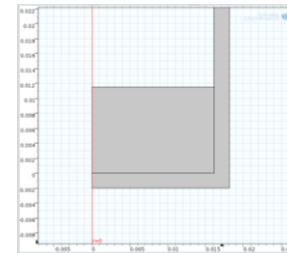
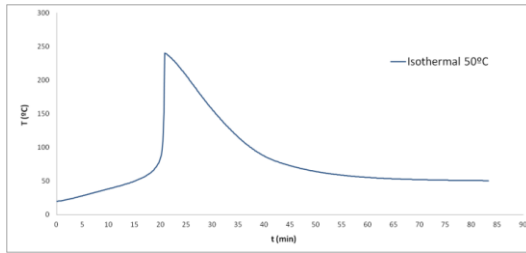
Funds from the European Union's Seventh Framework Programme (FP7/2007-2013) under grant agreement 309993. **Partners:** Fraunhofer ILT, Faurecia, Valeo, PSA, Armines, Andaltec, Lasea



**Objective:** to study the **curing kinetic** of an **epoxy resin** and the relationship between **the curing process parameters** and **final properties** of the thermoset networks

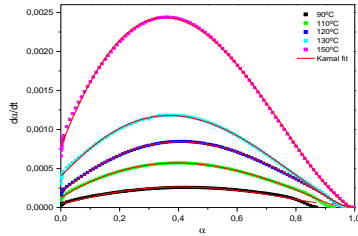
**Modelling Tools:** FEM Simulations, COMSOL, **Goal:** Coupling between **heat transfer & chemical kinetics**

Objective	Impact
Curing <b>evolution</b> in a viscoelastic thermoset polymer resin	Increase <b>process control</b>
<b>Predict and optimize curing cycles</b>	increase <b>process efficiency</b>
Obtain <b>high degrees of curing</b>	Improve <b>quality</b>
<b>Avoid heat degradation</b>	increase <b>durability</b>
<b>Reduce curing times</b>	Reduce <b>cost</b>





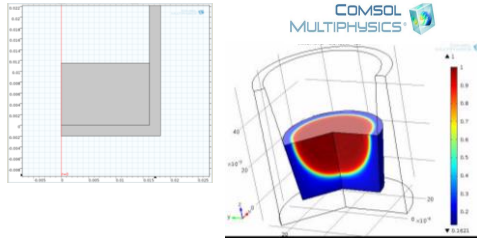
## 1. Thermal characterization of the curing kinetics



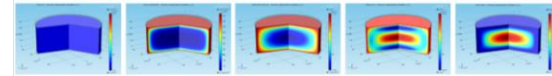
2. Obtaining of a **kinetic model** corresponding to the curing behaviour of a specific system (resin-curing agent)

$$d\alpha/dt = (k_1 + k_2\alpha^m)(1 - \alpha)^n$$

3. Simulation of a real piece, coupling chemical kinetics and heat transfer, using Levenberg-Marquardt **non-linear regression analysis**

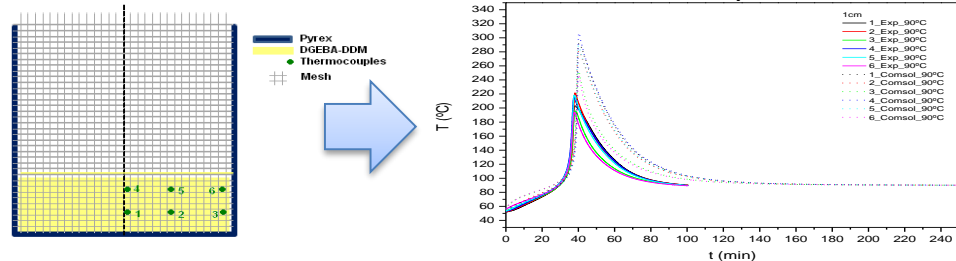


Mapping T°C and curing degree at any point and any time



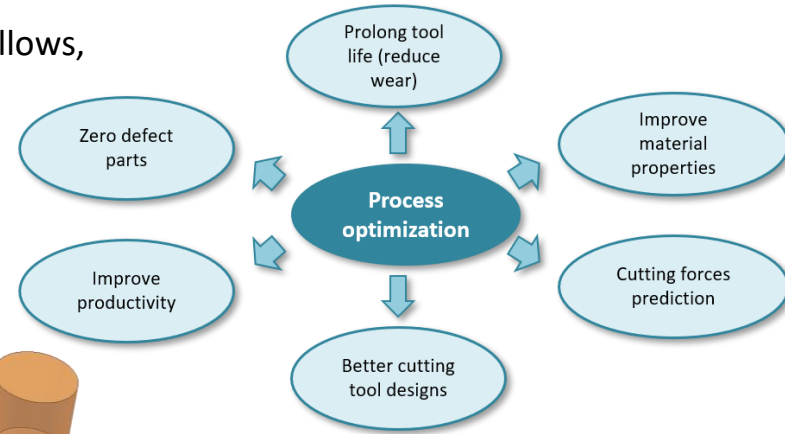
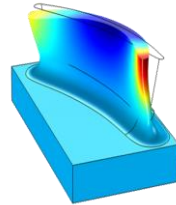
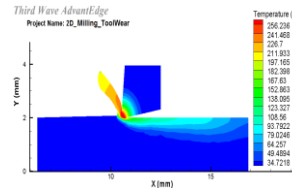
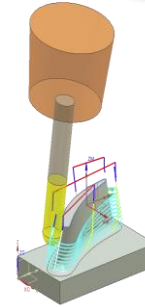
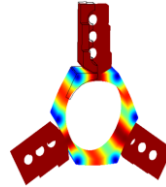
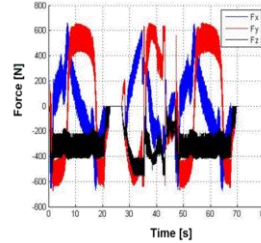
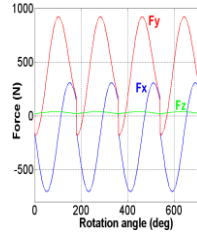
4. Validation of simulation (experimental test)

Good correlation in T°C values. Simulation vs Experimental

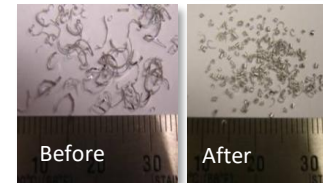
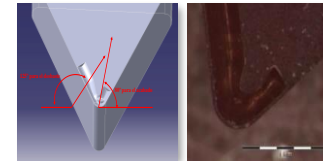


**Objective/Impact:** optimization of manufacturing processes. Models allows, **reducing the number of experiments** and **reducing costs**.

- Cutting and machining  
(Prediction of cutting force)
  - stability (chatter and vibrations)
  - Material removal
  - **Surface finishing forecast**
  - CAD/CAM Integration
  - Chip formation (**mechanical & thermal effects**)
  - **Clamping distortion**
- Heat Treatments
- Modal analysis
- Tool design
  - Tool geometry and performance analysis
  - Design of a chip breaker
  - Better milling tooth paths

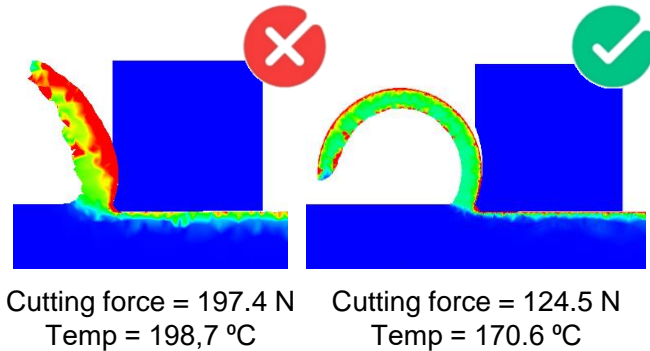


Design of a chip breaker

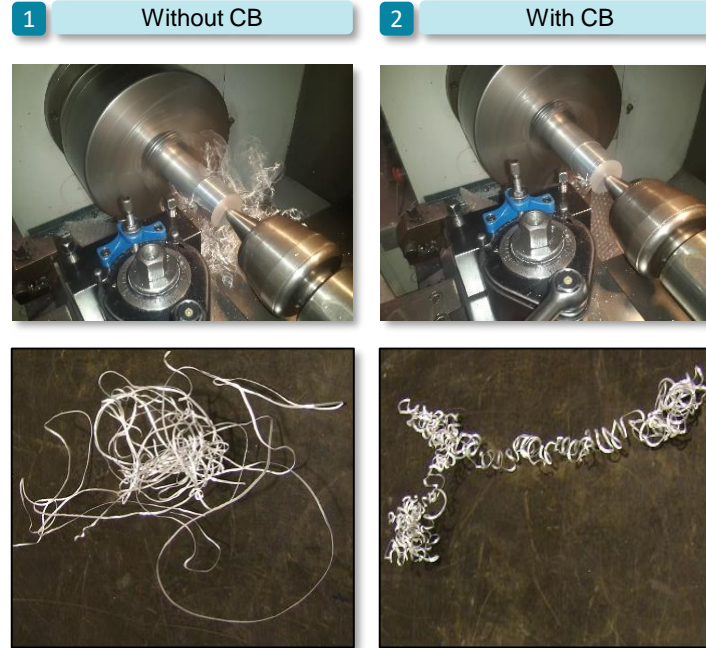


**Objective:** Design of chip-breakers geometry by FEM simulation

**Modelling Tool:** Advantage



+ Laser Additive manufacturing of the chip-breaker

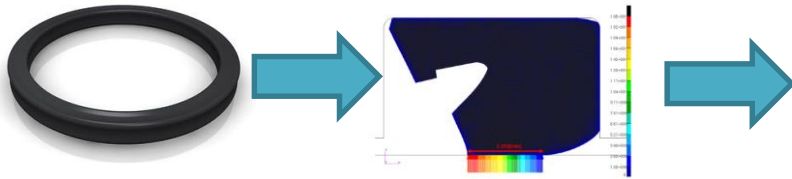


Turning of ductile materials (i.e. aluminium)

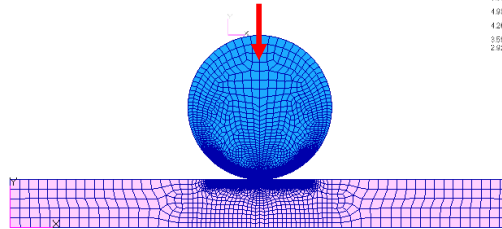
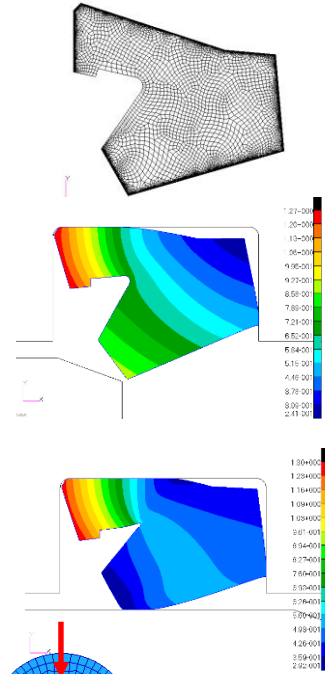


- Necessary data for building a model:
  - Basic properties
  - Mechanical tests
  - Material behaviour models

**Objective:** Simulation of the actual sealing system, to acquire information to design simplified tribological tests



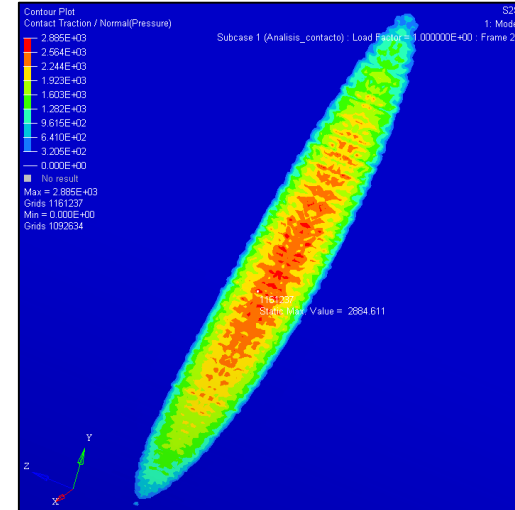
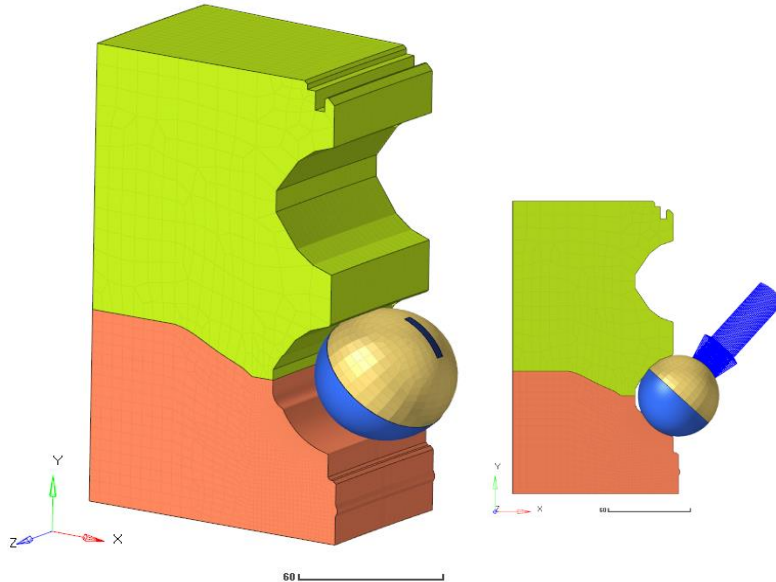
FEM of the component at actual working conditions



Definition of load for tribological testing conditions



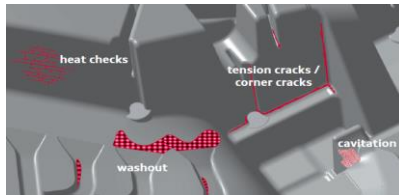
- Modelling tools (FEMS, KISSsoft, BEARINX)
- Calculation of the **contact pressure**, useful for the **prediction of different failures**: Rolling contact fatigue, false brinelling... (analytical formulas)



## MODELING MOLD WEAR PERFORMANCE

### THE FAILURE MECHANISM

- Thermal Fatigue
- Die Soldering
- Erosion
- Abrasion
- Corrosion



High Pressure  
Die Casting

Plastic Injection  
Molding

### THE NEED

**Example of Durability needs:**

100-300.000 castings

**Real durability:**

5000-25000 cycles

**Substitution cost** of mold

insert: 50000€

**Shutdown cost/day:** 3000€

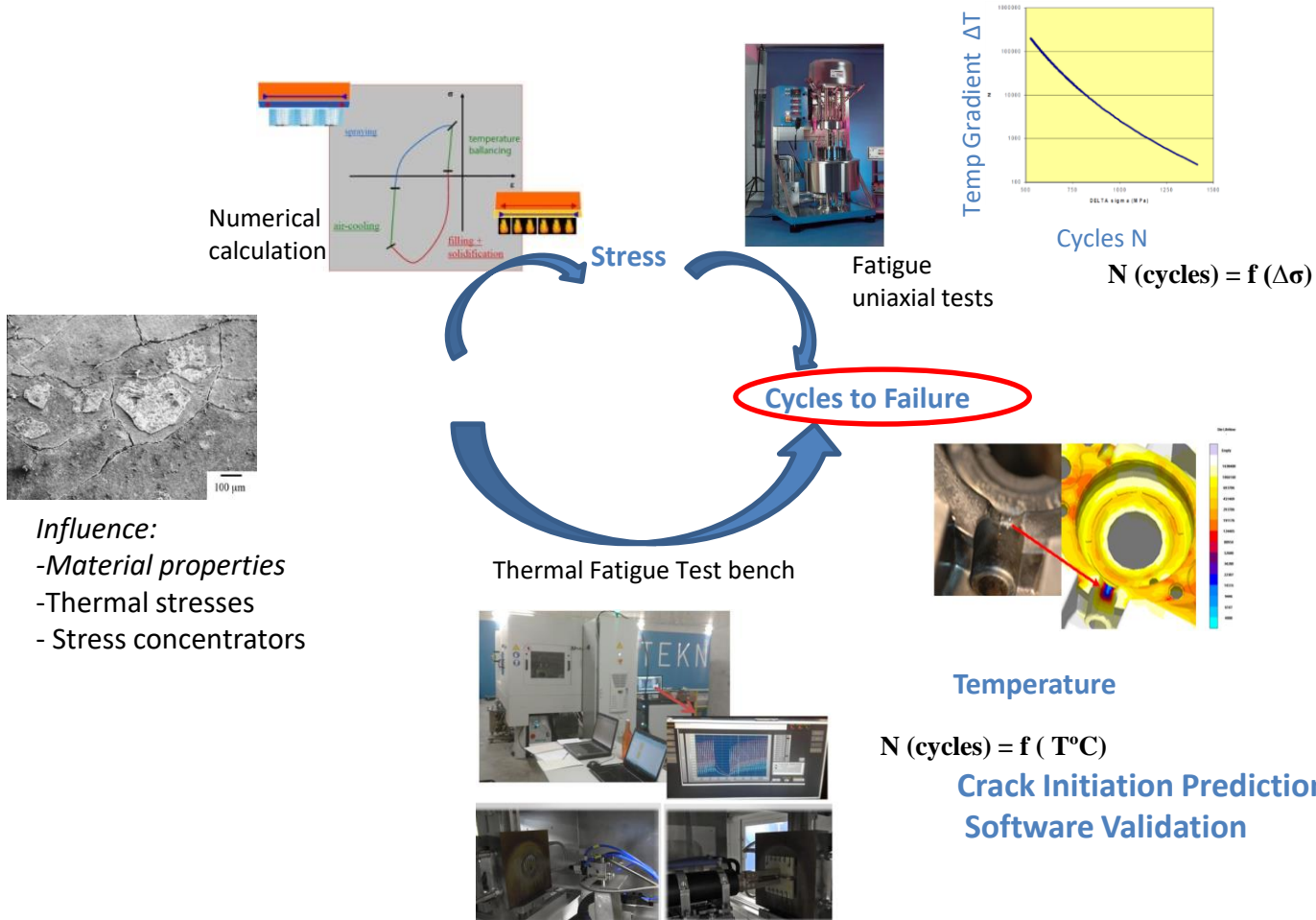


Financed by EU Commission Project Music: FoF-ICT-2011.7.1

Smart Factories: Energy-aware, agile manufacturing and customization







## HPDC Example:

### Thermal Fatigue

$$N(\text{cycles}) = f(\text{stress})$$

Where

S: thermal stress calculated (820-920 MPa)

### Die Soldering

$$N(\text{cycles}) = f(\text{Temperature, pressure})$$

Where:

T: Mould surface temperature (350 - 450°C)

P: Pressure in the mould surface (0 - 7 MPa),

K: depending on lubricant

### Erosion

$$\text{Wear}(\mu\text{m/h}) = f(\text{angle, speed, hardness})$$

Where:

VEL: flux speed (32-64m/s)

ANG: impact angle (15-90°)

H: Hardness (200-900HV)

## 4. Wear Modelling Implementation

### Reference case:

INPUT		
MaxT	400	°C
Thermal stress level	870	MPa
Pressure	1	MPa
Impact speed	50	m/s
Impact angle	30	°
Lubricant	2.68	D
Die material	1	H13

### Failure prediction:

OUTPUT		
Thermal Fatigue	7369	Cycles
Die Soldering	956	Cycles
Erosion	17269	Cycles

### Improved case:

INPUT		
MaxT	400	°C
Thermal stress level	820	MPa
Pressure	1	MPa
Impact speed	40	m/s
Impact angle	30	°
Lubricant	1	A
Die material	1	H13

### Failure prediction:

OUTPUT		
Thermal Fatigue	<b>18026</b>	<b>Cycles</b>
Die Soldering	<b>11286</b>	<b>Cycles</b>
Erosion	<b>30698</b>	<b>Cycles</b>

**time for mould reparation x 2**  
**time for maintenance stops x 10**

## CONCLUSIONS

### The use of modelling to:

- Molecular Dynamic and Atomistic modelling to predict **properties at the nanoscale**
- **Piezoelectric simulation** has been used for product (nebulizer) design
- Optimization of **laser and curing processing** by modelling
- **Machining models** to improve the process, reduce the experimental set-up
- **New tool geometries** to reduce manufacturing errors.
- Use **FEM tools** to **predict failure** modes analytically and define tribological tests
- Prediction failure modes lifetime: constructing innovative equipment's, reproducing wear mechanisms, **building lifetime equations from experimental data**

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